

In the Claims

Claim 11 has been amended as follows:

Sub B1
11. (Amended) A thermal bubble inkjet head having a symmetrical off-shooter heater comprising:

A3
a silicon substrate having a top surface and a bottom surface;

a first insulating material layer of at least 1000Å thick on said top surface;

a funnel-shaped manifold formed in said silicon substrate;

a symmetrical ring-shaped heater formed on said first insulating material layer on said top surface;

an interconnect formed of a conductive metal in electrical communication with said ring-shaped heater;

a third insulating material layer on top of said ring-shaped heater and said first insulating material layer;

a first photoresist layer of at least 2000Å thick on top of said third insulating material layer;

an ink chamber formed in said first photoresist layer in fluid communication with said funnel-shaped manifold;